

# NSS40300MZ4, NSV40300MZ4T1G

## Bipolar Power Transistors 40 V, 3.0 A, Low $V_{CE(sat)}$ PNP Transistor

ON Semiconductor's e<sup>2</sup>PowerEdge family of low  $V_{CE(sat)}$  transistors are surface mount devices featuring ultra low saturation voltage ( $V_{CE(sat)}$ ) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e<sup>2</sup>PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

### Features

- AEC-Q101 Qualified and PPAP Capable
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant\*



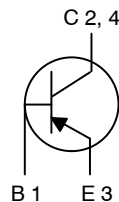
ON Semiconductor®

<http://onsemi.com>

**PNP TRANSISTOR  
3.0 AMPERES  
40 VOLTS, 2.0 WATTS**

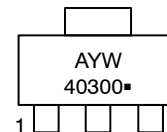


**SOT-223  
CASE 318E  
STYLE 1**



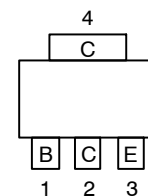
Schematic

### MARKING DIAGRAM



A = Assembly Location  
Y = Year  
W = Work Week  
40300 = Specific Device Code  
▪ = Pb-Free Package

### PIN ASSIGNMENT



Top View Pinout

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NSS40300MZ4, NSV40300MZ4T1G

## MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector–Base Voltage	V <sub>CB</sub>	40	Vdc
Emitter–Base Voltage	V <sub>EB</sub>	6.0	Vdc
Base Current – Continuous	I <sub>B</sub>	1.0	Adc
Collector Current Continuous Peak	I <sub>C</sub>	3.0 5.0	Adc
Total Power Dissipation Total P <sub>D</sub> @ T <sub>A</sub> = 25°C mounted on 1" sq. (645 sq. mm) Collector pad on FR–4 bd material Total P <sub>D</sub> @ T <sub>A</sub> = 25°C mounted on 0.012" sq. (7.6 sq. mm) Collector pad on FR–4 bd material	P <sub>D</sub>	2.0 0.80	W
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction–to–Case Junction–to–Ambient on 1" sq. (645 sq. mm) Collector pad on FR–4 bd material Junction–to–Ambient on 0.012" sq. (7.6 sq. mm) Collector pad on FR–4 bd material	R <sub>θJA</sub> R <sub>θJA</sub>	64 155	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	T <sub>L</sub>	260	°C

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NSS40300MZ4T1G	SOT–223 (Pb–Free)	1,000 / Tape & Reel
NSV40300MZ4T1G	SOT–223 (Pb–Free)	1,000 / Tape & Reel
NSS40300MZ4T3G	SOT–223 (Pb–Free)	4,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NSS40300MZ4, NSV40300MZ4T1G

## ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

Collector–Emitter Sustaining Voltage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0 A)	V <sub>CEO(sus)</sub>	40	–	–	Vdc
Emitter–Base Voltage (I <sub>E</sub> = 50 μA, I <sub>C</sub> = 0 A)	V <sub>EBO</sub>	6.0	–	–	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 40 Vdc)	I <sub>CBO</sub>	–	–	100	nA
Emitter Cutoff Current (V <sub>BE</sub> = 6.0 Vdc)	I <sub>EBO</sub>	–	–	100	nA

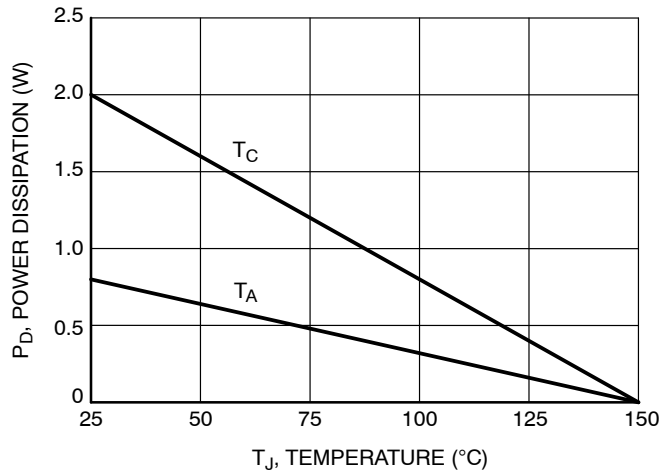
### ON CHARACTERISTICS (Note 1)

Collector–Emitter Saturation Voltage (I <sub>C</sub> = 0.5 A, I <sub>B</sub> = 50 mA) (I <sub>C</sub> = 1.0 A, I <sub>B</sub> = 20 mA) (I <sub>C</sub> = 3.0 A, I <sub>B</sub> = 0.3 A)	V <sub>CE(sat)</sub>	–	–	0.070 0.150 0.400	Vdc
Base–Emitter Saturation Voltage (I <sub>C</sub> = 1.0 A, I <sub>B</sub> = 0.1 A)	V <sub>BE(sat)</sub>	–	–	1.0	Vdc
Base–Emitter On Voltage (I <sub>C</sub> = 1.0 A, V <sub>CE</sub> = 2.0 Vdc)	V <sub>BE(on)</sub>	–	–	0.9	Vdc
DC Current Gain (I <sub>C</sub> = 0.5 A, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 1.0 A, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 3.0 A, V <sub>CE</sub> = 1.0 Vdc)	h <sub>FE</sub>	200 175 100	– – –	– 350 –	–

### DYNAMIC CHARACTERISTICS

Output Capacitance (V <sub>CB</sub> = 10 Vdc, f = 1.0 MHz)	C <sub>ob</sub>	–	40	–	pF
Input Capacitance (V <sub>EB</sub> = 5.0 Vdc, f = 1.0 MHz)	C <sub>ib</sub>	–	130	–	pF
Current–Gain – Bandwidth Product (Note 2) (I <sub>C</sub> = 500 mA, V <sub>CE</sub> = 10 V, F <sub>test</sub> = 1.0 MHz)	f <sub>T</sub>	–	160	–	MHz

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
2. f<sub>T</sub> = |h<sub>FE</sub>| • f<sub>test</sub>



**Figure 1. Power Derating**

TYPICAL CHARACTERISTICS

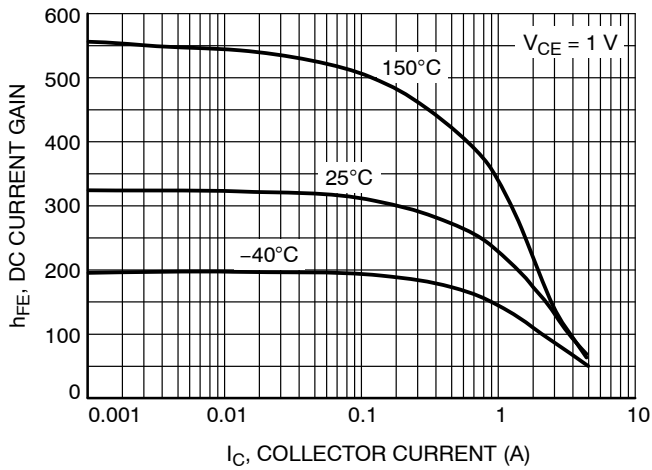


Figure 2. DC Current Gain

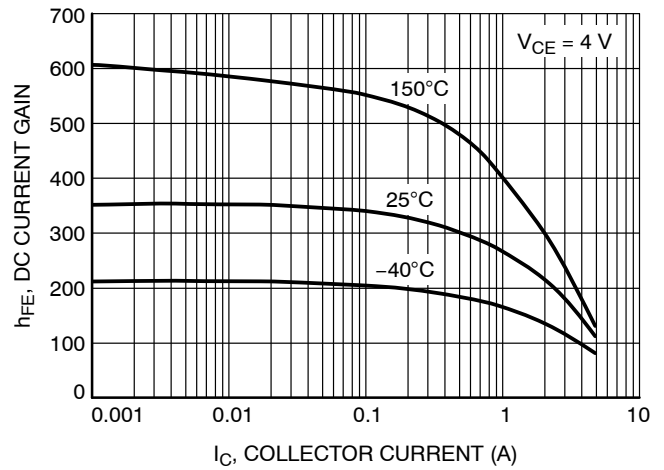


Figure 3. DC Current Gain

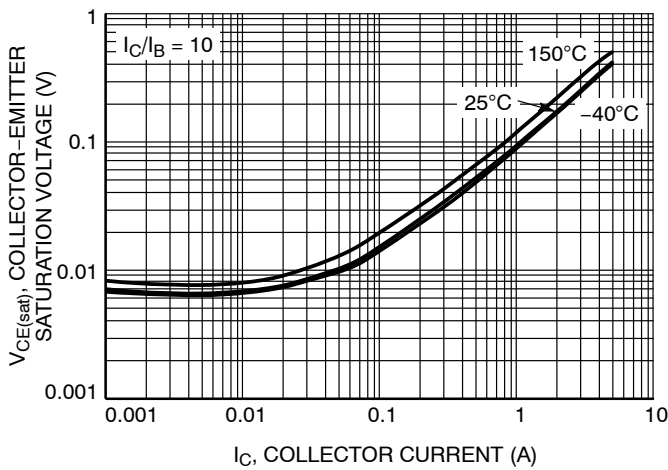


Figure 4. Collector-Emitter Saturation Voltage

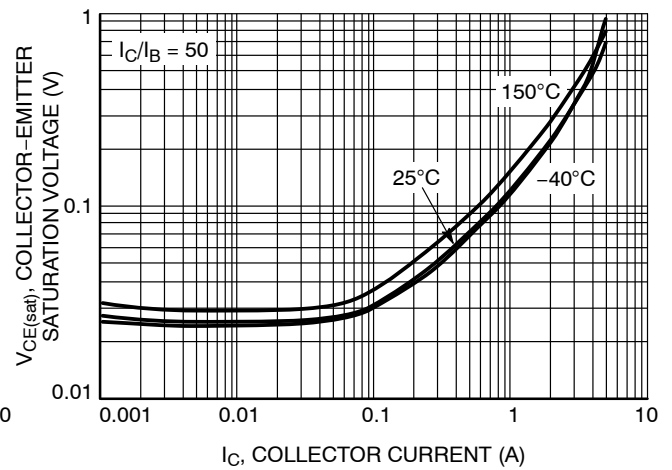


Figure 5. Collector-Emitter Saturation Voltage

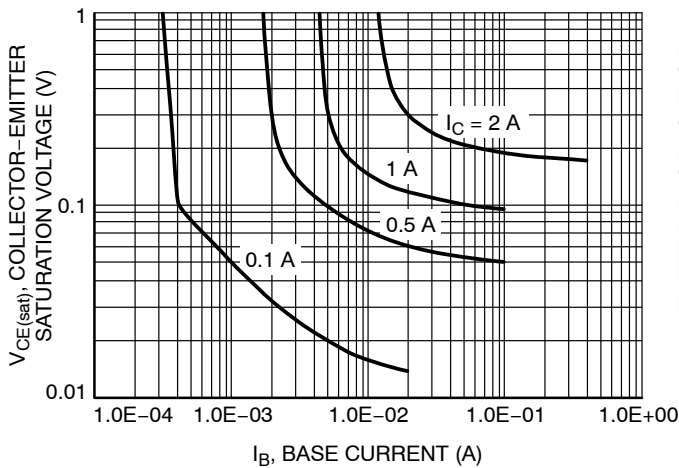


Figure 6. Collector Saturation Region

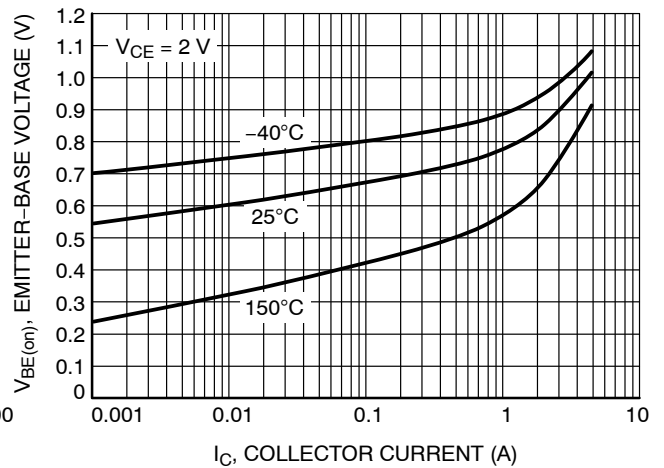


Figure 7.  $V_{BE(on)}$  Voltage

TYPICAL CHARACTERISTICS

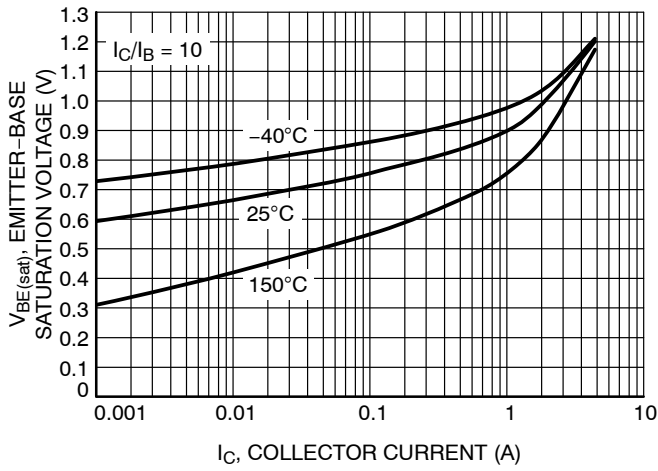


Figure 8. Base-Emitter Saturation Voltage

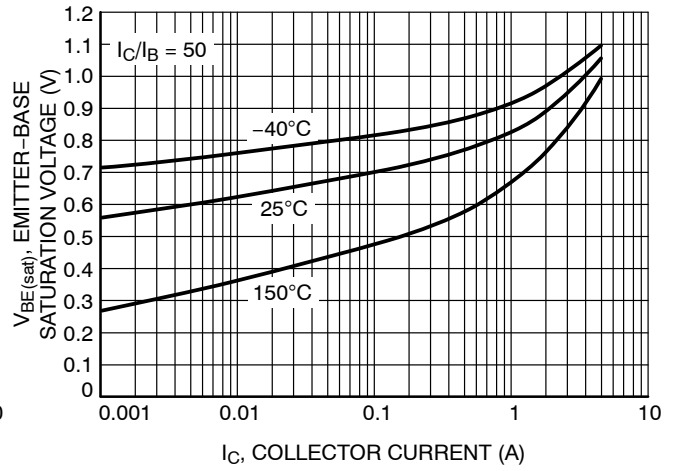


Figure 9. Base-Emitter Saturation Voltage

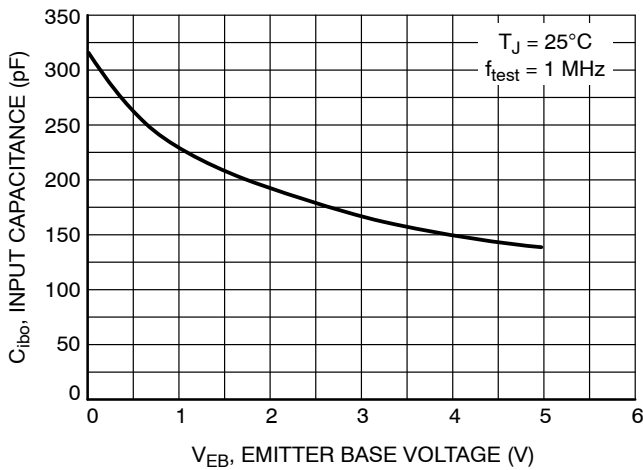


Figure 10. Input Capacitance

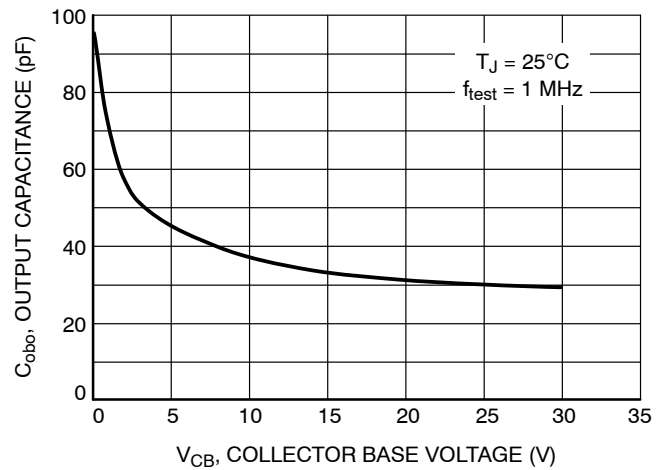


Figure 11. Output Capacitance

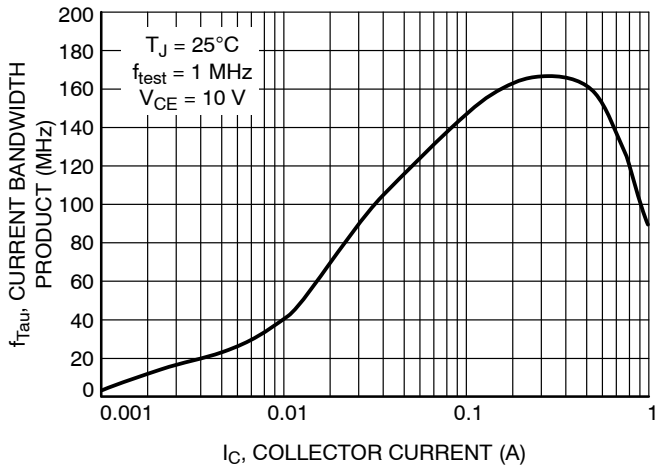


Figure 12. Current-Gain Bandwidth Product

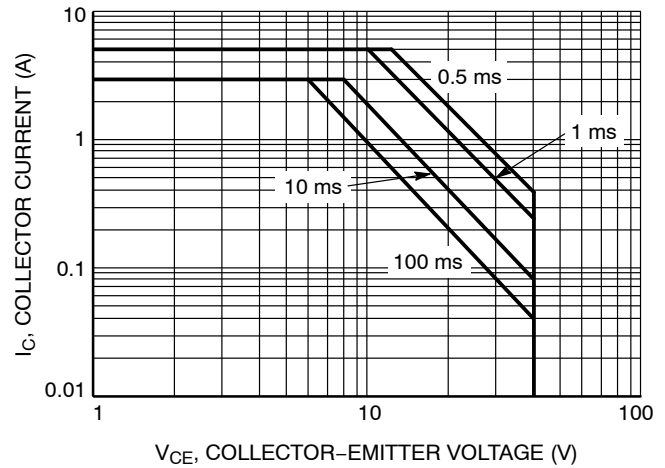
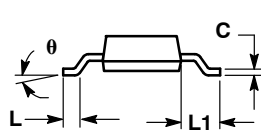
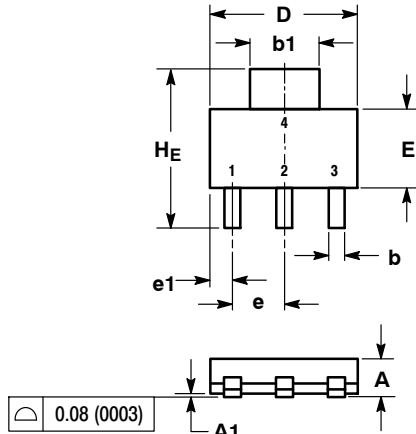


Figure 13. Safe Operating Area

# NSS40300MZ4, NSV40300MZ4T1G

## PACKAGE DIMENSIONS

SOT-223 (TO-261)  
CASE 318E-04  
ISSUE N

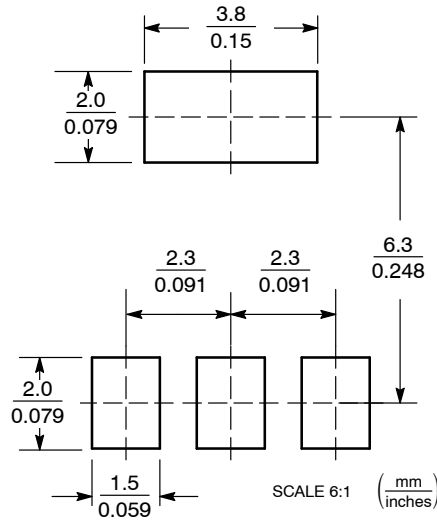


NOTES:  
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.  
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
c	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
E	3.30	3.50	3.70	0.130	0.138	0.145
e	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20	---	---	0.008	---	---
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	-	10°	0°	-	10°

STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- Оценку стоимости проекта по компонентам.
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